

### P-channel -30V, -55A, TO-252 Power MOSFET 功率場效應管

#### ■ Features 特點

Low on-resistance and maximum DC current capability 低導通電阻和最大直流電流能力

Super high density cell design 超高元胞密度設計

$R_{DS(ON)} < 10\text{m}\Omega$  @  $V_{GS} = -10\text{V}$

$R_{DS(ON)} < 15\text{m}\Omega$  @  $V_{GS} = -4.5\text{V}$

#### ■ Applications 應用

Power Management in Note book 筆記本電源管理

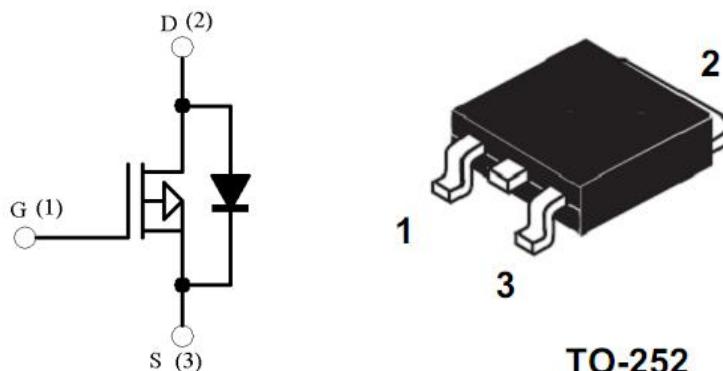
Portable Equipment 便攜式設備

Battery Powered System 電池電源系統

DC/DC Converter 直流/直流變換

Load Switch 負載開關應用

#### ■ Internal Schematic Diagram 內部結構



#### ■ Absolute Maximum Ratings 最大額定值

Characteristic 特性參數	Symbol 符號	Max 最大值	Unit 單位
Drain-Source Voltage 漏極-源極電壓	$BV_{DSS}$	-30	V
Gate- Source Voltage 柄極-源極電壓	$V_{GS}$	$\pm 20$	V
Drain Current (continuous)漏極電流-連續	$I_D$ (at $TA = 25^\circ\text{C}$ )	-55	A
Drain Current (pulsed)漏極電流-脈沖	$I_{DM}$	-130	A
Total Device Dissipation 總耗散功率 at $TA = 25^\circ\text{C}$ at $TA = 100^\circ\text{C}$	$P_{TOT}$ (at $TA = 25^\circ\text{C}$ ) at $TA = 100^\circ\text{C}$ )	23 13	W
Thermal Resistance Junction-Ambient 热阻	$R_{\Theta JA}$	55	$^\circ\text{C}/\text{W}$
Junction/Storage Temperature 結溫/儲存溫度	$T_J, T_{stg}$	-55~150	$^\circ\text{C}$

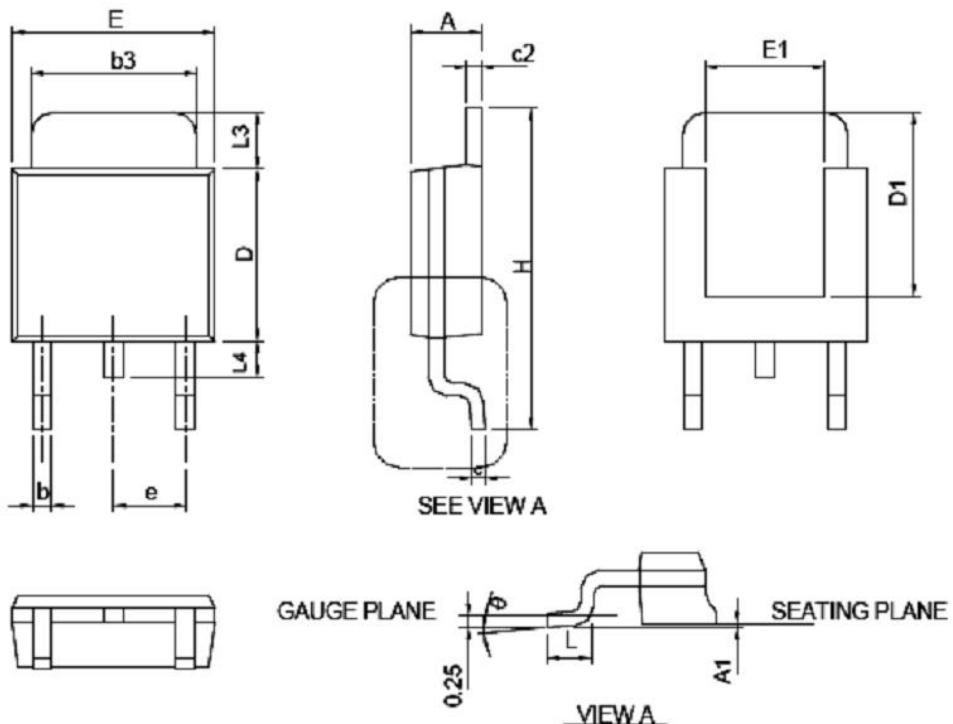
■ Electrical Characteristics 電特性

( $T_A=25^\circ\text{C}$  unless otherwise noted 如無特殊說明，溫度為  $25^\circ\text{C}$ )

Characteristic 特性參數	Symbol 符號	Min 最小值	Typ 典型值	Max 最大值	Unit 單位
Drain-Source Breakdown Voltage 漏極-源極擊穿電壓( $I_D = -250\mu\text{A}, V_{GS} = 0\text{V}$ )	$\text{BV}_{\text{DSS}}$	-30	—	—	V
Gate Threshold Voltage 柵極開启電壓( $I_D = -250\mu\text{A}, V_{GS} = V_{DS}$ )	$V_{GS(\text{th})}$	-1	-1.6	-2.5	V
Zero Gate Voltage Drain Current 零柵壓漏極電流( $V_{GS} = 0\text{V}, V_{DS} = -30\text{V}$ )	$I_{\text{DSS}}$	—	—	-1	$\mu\text{A}$
Gate Body Leakage 柵極漏電流( $V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$ )	$I_{GSS}$	—	—	$\pm 100$	nA
Static Drain-Source On-State Resistance 静态漏源導通電阻( $I_D = -25\text{A}, V_{GS} = -10\text{V}$ ) ( $I_D = -20\text{A}, V_{GS} = -4.5\text{V}$ )	$R_{DS(\text{ON})}$	—	8 12	10 15	$\text{m}\Omega$
Diode Forward Voltage Drop 內附二極管正向壓降( $I_{SD} = -1.7\text{A}, V_{GS} = 0\text{V}$ )	$V_{SD}$	—	—	-1.2	V
Input Capacitance 輸入電容 ( $V_{GS} = 0\text{V}, V_{DS} = -15\text{V}, f = 1\text{MHz}$ )	$C_{ISS}$	—	2600	—	pF
Common Source Output Capacitance 共源輸出電容( $V_{GS} = 0\text{V}, V_{DS} = -15\text{V}, f = 1\text{MHz}$ )	$C_{OSS}$	—	600	—	pF
Gate Source Charge 柵源電荷密度 ( $V_{DS} = -15\text{V}, I_D = -1\text{A}, V_{GS} = -10\text{V}$ )	$Q_{gs}$	—	3	—	nC
Gate Drain Charge 柵漏電荷密度 ( $V_{DS} = -15\text{V}, I_D = -1\text{A}, V_{GS} = -10\text{V}$ )	$Q_{gd}$	—	8	—	nC
Turn-On Delay Time 開啟延遲時間 ( $V_{DS} = -15\text{V}, I_D = -1\text{A}, R_{\text{GEN}} = 6\Omega, V_{GS} = -10\text{V}$ )	$t_{d(on)}$	—	18	—	ns
Turn-On Rise Time 開啟上升時間 ( $V_{DS} = -15\text{V}, I_D = -1\text{A}, R_{\text{GEN}} = 6\Omega, V_{GS} = -10\text{V}$ )	$t_r$	—	18	—	ns
Turn-Off Delay Time 關斷延遲時間 ( $V_{DS} = -15\text{V}, I_D = -1\text{A}, R_{\text{GEN}} = 6\Omega, V_{GS} = -10\text{V}$ )	$t_{d(off)}$	—	160	—	ns
Turn-On Fall Time 開啟下降時間 ( $V_{DS} = -15\text{V}, I_D = -1\text{A}, R_{\text{GEN}} = 6\Omega, V_{GS} = -10\text{V}$ )	$t_f$	—	96	—	ns



■DIMENSION 外形封裝尺寸



SYMBOL	TO-252			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1		0.13		0.005
b	0.50	0.89	0.020	0.035
b3	4.95	5.46	0.195	0.215
c	0.46	0.61	0.018	0.024
c2	0.46	0.89	0.018	0.035
D	5.33	6.22	0.210	0.245
D1	4.57	6.00	0.180	0.236
E	6.35	6.73	0.250	0.265
E1	3.81	6.00	0.150	0.236
e	2.29 BSC		0.090 BSC	
H	9.40	10.41	0.370	0.410
L	0.90	1.78	0.035	0.070
L3	0.89	2.03	0.035	0.080
L4		1.02		0.040
0	0°	8°	0°	8°